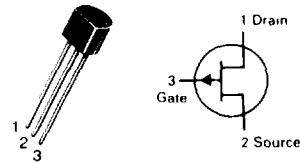


MPF970 MPF971

CASE 29-04, STYLE 5
TO-92 (TO-226AA)



JFET SWITCHING

P-CHANNEL — DEPLETION

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	25	Vdc
Drain-Gate Voltage	V _{DG}	30	Vdc
Reverse Gate-Source Voltage	V _{GSR}	30	Vdc
Forward Gate Current	I _{G(f)}	10	mAdc
Total Device Dissipation (α T _A = 25°C Derate above 25°C)	P _D	350 2.8	mW mW/C
Storage Channel Temperature Range	T _{stg}	-65 to +150	°C
Operating Temperature Range	T _{channel}	-65 to +150	°C

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted.)

Characteristic		Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Gate-Source Breakdown Voltage (I _G = 1.0 μAdc, V _{DS} = 0)		V(BR)GSS	30	—	—	Vdc
Gate Reverse Current (V _{GS} = 15 Vdc, V _{DS} = 0) (V _{GS} = 15 Vdc, V _{DS} = 0, T _A = 150°C)		I _{GSS}	—	—	1.0 1.0	nAdc μAdc
Drain-Cutoff Current (V _{DS} = 15 Vdc, V _{GS} = 12 Vdc) (V _{DS} = 15 Vdc, V _{GS} = 12 Vdc, T _A = 150°C) (V _{DS} = 15 Vdc, V _{GS} = 7.0 Vdc) (V _{DS} = 15 Vdc, V _{GS} = 7.0 Vdc, T _A = 150°C)	MPF970 MPF970 MPF971 MPF971	I _{D(off)}	— — — —	— — — —	10 10 10 10	nAdc μAdc nAdc μAdc
Gate Source Cutoff Voltage (V _{DS} = 15 Vdc, I _D = 10 nAdc)	MPF970 MPF971	V _{GS(off)}	5.0 1.0	— —	12 7.0	Vdc
ON CHARACTERISTICS						
Zero-Gate-Voltage Drain Current(1) (V _{DS} = 20 Vdc, V _{GS} = 0)	MPF970 MPF971	I _{DSS}	15 2.0	— —	100 50	mAdc
Drain-Source On-Voltage (I _D = 10 mAdc, V _{GS} = 0) (I _D = 1.5 mAdc, V _{GS} = 0)		V _{DS(on)}	— —	— —	1.5 1.5	Vdc
Static Drain-Source On Resistance (I _D = 1.0 mAdc, V _{GS} = 0)	MPF970 MPF971	r _{DS(on)}	— —	— —	100 250	Ohms
SMALL-SIGNAL CHARACTERISTICS						
Drain-Source "ON" Resistance (V _{GS} = 0, I _D = 0, f = 1.0 kHz)	MPF970 MPF971	r _{ds(on)}	— —	— —	100 250	Ohms
Input Capacitance (V _{GS} = 12 Vdc, V _{DS} = 0, f = 1.0 MHz) (V _{GS} = 7.0 Vdc, V _{DS} = 0, f = 1.0 MHz)	MPF970 MPF971	C _{iss}	— —	— —	12 12	pF
Reverse Transfer Capacitance (V _{GS} = 12 Vdc, V _{DS} = 0, f = 1.0 MHz) (V _{GS} = 7.0 Vdc, V _{DS} = 0, f = 1.0 MHz)	MPF970 MPF971	C _{rss}	— —	— —	5.0 5.0	pF

ELECTRICAL CHARACTERISTICS (continued) ($T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
SWITCHING CHARACTERISTICS (See Figure 6, $R_K = 0$) (1)					
Rise Time $(I_{D(on)} = 10 \text{ mAdc}, V_{GS(off)} = 12 \text{ Vdc})$ $(I_{D(on)} = 1.5 \text{ mAdc}, V_{GS(off)} = 7.0 \text{ Vdc})$	MPF970 MPF971	t_r	— —	2.0 3.0	5.0 5.0
Fall Time $(I_{D(on)} = 10 \text{ mAdc}, V_{GS(off)} = 12 \text{ Vdc})$ $(I_{D(on)} = 1.5 \text{ mAdc}, V_{GS(off)} = 7.0 \text{ Vdc})$	MPF970 MPF971	t_f	— —	9.0 68	15 80
Turn-On Time $(I_{D(on)} = 10 \text{ mAdc}, V_{GS(off)} = 12 \text{ Vdc})$ $(I_{D(on)} = 1.5 \text{ mAdc}, V_{GS(off)} = 7.0 \text{ Vdc})$	MPF970 MPF971	t_{on}	— —	3.5 5.0	8.0 10
Turn-Off Time $(I_{D(on)} = 10 \text{ mAdc}, V_{GS(off)} = 12 \text{ Vdc})$ $(I_{D(on)} = 1.5 \text{ mAdc}, V_{GS(off)} = 7.0 \text{ Vdc})$	MPF970 MPF971	t_{off}	— —	13 88	25 120

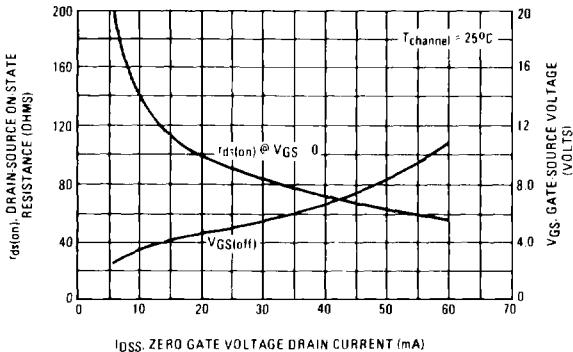
(1) Pulse Test: Pulse Width $\leq 100 \mu\text{s}$. Duty Cycle $\sim 1.0\%$.FIGURE 1 – EFFECT OF $I_{DS(on)}$ ON DRAIN-SOURCE RESISTANCE AND GATE SOURCE VOLTAGE

FIGURE 2 – TURN-ON DELAY TIME

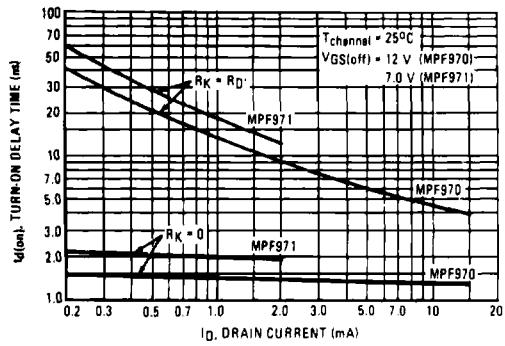
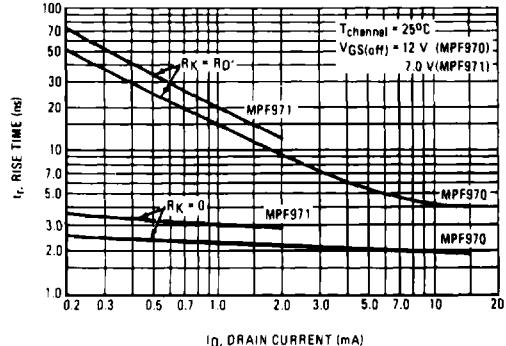


FIGURE 3 – RISE TIME



MPF970 MPF971

FIGURE 4 – TURN-OFF DELAY TIME

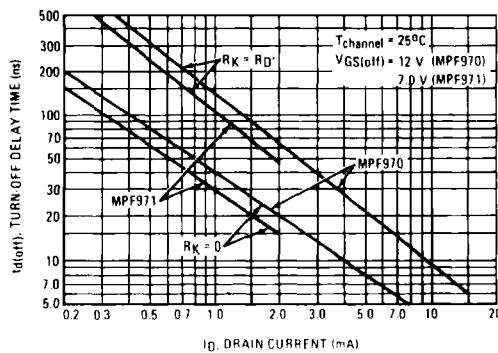


FIGURE 5 – FALL TIME

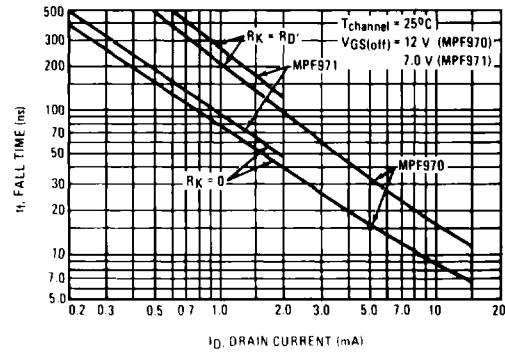
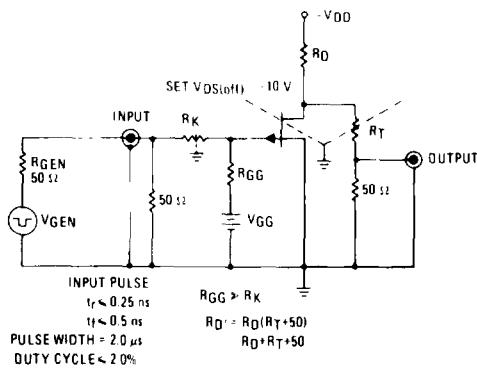


FIGURE 6 – SWITCHING TIME TEST CIRCUIT



NOTE 1

The switching characteristics shown above were measured using a test circuit similar to Figure 6. At the beginning of the switching interval, the gate voltage is at Gate Supply Voltage ($+V_{GG}$). The Drain-Source Voltage (V_{DS}) is slightly lower than Drain Supply Voltage (V_{DD}) due to the voltage divider. Thus Reverse Transfer Capacitance (C_{rss}) or Gate-Drain Capacitance (C_{gd}) is charged to $V_{GG} + V_{DS}$.

During the turn-on interval, Gate-Source Capacitance (C_{gs}) discharges through the series combination of R_{GEN} and R_K . C_{gd} must discharge to $V_{DS(on)}$ through R_G and R_K in series with the parallel combination of effective load impedance (R'_D) and Drain-Source Resistance (r_{ds}). During the turn-off, this charge flow is reversed.

Predicting turn-on time is somewhat difficult as the channel resistance r_{ds} is a function of the gate-source voltage. While C_{gs} discharges, V_{GS} approaches zero and r_{ds} decreases. Since C_{gd} discharges through r_{ds} , turn-on time is non-linear. During turn-off, the situation is reversed with r_{ds} increasing as C_{gd} charges.

The above switching curves show two impedance conditions: 1) R_K is equal to R_D , which simulates the switching behavior of cascaded stages where the driving source impedance is normally the load impedance of the previous stage, and 2) $R_K = 0$ (low impedance) the driving source impedance is that of the generator.

FIGURE 7 – TYPICAL FORWARD TRANSFER ADMITTANCE

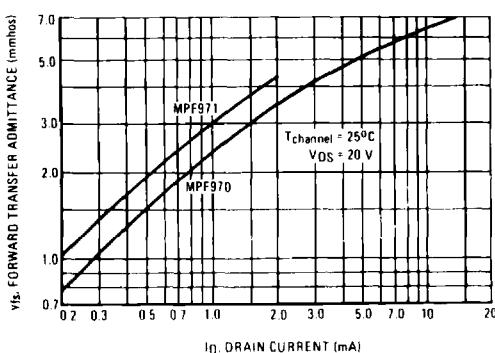


FIGURE 8 – TYPICAL CAPACITANCE

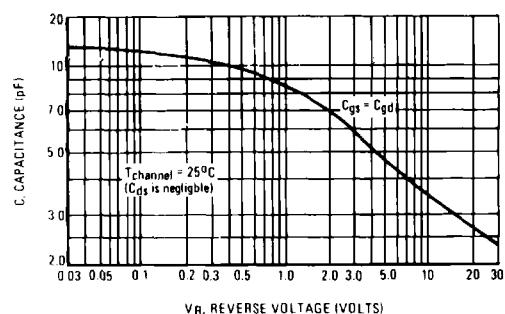


FIGURE 9 – EFFECT OF GATE-SOURCE VOLTAGE ON DRAIN-SOURCE RESISTANCE

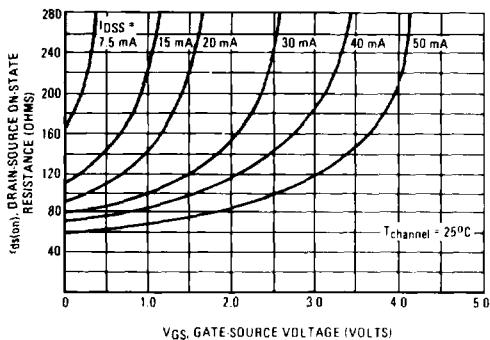


FIGURE 10 – EFFECT OF TEMPERATURE ON DRAIN-SOURCE ON-STATE RESISTANCE

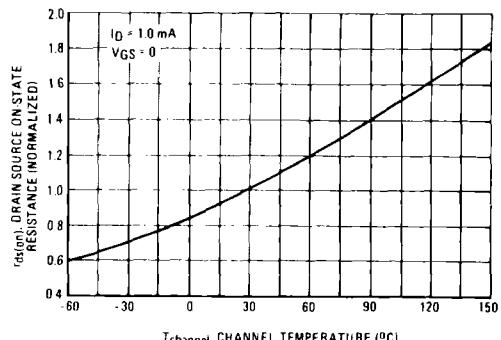


FIGURE 11 – LOW FREQUENCY CIRCUIT MODEL

